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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	AVR
Core Size	8-Bit
Speed	4MHz
Connectivity	SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	32
Program Memory Size	8KB (4K x 16)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.6x16.6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at90s8515a-4jc

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Crystal Oscillator

XTAL1 and XTAL2 are input and output, respectively, of an inverting amplifier that can be configured for use as an on-chip oscillator, as shown in Figure 2. Either a quartz crystal or a ceramic resonator may be used. To drive the device from an external clock source, XTAL2 should be left unconnected while XTAL1 is driven as shown in Figure 3.

Figure 2. Oscillator Connections



- Note: When using the MCU oscillator as a clock for an external device, an HC buffer should be connected as indicated in the figure.
- Figure 3. External Clock Drive Configuration



Architectural Overview

The fast-access register file concept contains 32×8 -bit general-purpose working registers with a single clock cycle access time. This means that during one single clock cycle, one ALU (Arithmetic Logic Unit) operation is executed. Two operands are output from the register file, the operation is executed and the result is stored back in the register file – in one clock cycle.

Six of the 32 registers can be used as three 16-bit indirect address register pointers for Data Space addressing, enabling efficient address calculations. One of the three address pointers is also used as the address pointer for the constant table look-up function. These added function registers are the 16-bit X-, Y-, and Z-register.

The ALU supports arithmetic and logic functions between registers or between a constant and a register. Single register operations are also executed in the ALU. Figure 4 shows the AT90S8515 AVR RISC microcontroller architecture.

In addition to the register operation, the conventional memory addressing modes can be used on the register file as well. This is enabled by the fact that the register file is assigned the 32 lowermost Data Space addresses (\$00 - \$1F), allowing them to be accessed as though they were ordinary memory locations.

The I/O memory space contains 64 addresses for CPU peripheral functions such as Control Registers, Timer/Counters, A/D converters and other I/O functions. The I/O memory can be accessed directly or as the Data Space locations following those of the register file, \$20 - \$5F.

The AVR uses a Harvard architecture concept – with separate memories and buses for program and data. The program memory is executed with a two-stage pipeline. While one instruction is being executed, the next instruction is pre-fetched from the program memory. This concept enables instructions to be executed in every clock cycle. The program memory is In-System Programmable Flash memory.

With the relative jump and call instructions, the whole 4K address space is directly accessed. Most AVR instructions have a single 16-bit word format. Every program memory address contains a 16- or 32-bit instruction.

During interrupts and subroutine calls, the return address Program Counter (PC) is stored on the stack. The stack is effectively allocated in the general data SRAM and consequently, the stack size is only limited by the total SRAM size and the usage of the SRAM. All user programs must initialize the SP in the reset routine (before subroutines or interrupts are executed). The 16-bit Stack Pointer (SP) is read/write-accessible in the I/O space.

The 512-byte data SRAM can be easily accessed through the five different addressing modes supported in the AVR architecture.

The memory spaces in the AVR architecture are all linear and regular memory maps.





General-purpose Register File

Figure 6 shows the structure of the 32 general-purpose working registers in the CPU.

Figure 6. AVR CPU General-purpose Working Registers



X-register low byte X-register high byte Y-register low byte Y-register high byte Z-register low byte Z-register high byte

All the register operating instructions in the instruction set have direct and single-cycle access to all registers. The only exception are the five constant arithmetic and logic instructions SBCI, SUBI, CPI, ANDI and ORI between a constant and a register and the LDI instruction for load immediate constant data. These instructions apply to the second half of the registers in the register file (R16..R31). The general SBC, SUB, CP, AND and OR and all other operations between two registers or on a single register apply to the entire register file.

As shown in Figure 6, each register is also assigned a data memory address, mapping them directly into the first 32 locations of the user Data Space. Although not being physically implemented as SRAM locations, this memory organization provides great flexibility in access of the registers, as the X-, Y- and Z-registers can be set to index any register in the file.

The registers R26..R31 have some added functions to their general-purpose usage. These registers are address pointers for indirect addressing of the Data Space. The three indirect address registers X, Y, and Z are defined as:



Figure 7. X-, Y-, and Z-registers

AT90S8515

X-register, Y-register and

Z-register

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A 16-bit data address is contained in the 16 LSBs of a 2-word instruction. Rd/Rr specify the destination or source register.





Operand address is the result of the Y- or Z-register contents added to the address contained in six bits of the instruction word.

Figure 14. Data Indirect Addressing



Operand address is the contents of the X-, Y-, or the Z-register.

Figure 15. Data Indirect Addressing with Pre-decrement





Data Indirect with Displacement

Data Indirect

Data Indirect with Pre-

decrement

Figure

I/O Memory

The I/O space definition of the AT90S8515 is shown in Table 1.

Table 1. AT90S8515 I/O Space

Address Hex	Name	Function			
\$3F (\$5F)	SREG	Status Register			
\$3E (\$5E)	SPH	Stack Pointer High			
\$3D (\$5D)	SPL	Stack Pointer Low			
\$3B (\$5B)	GIMSK	General Interrupt Mask register			
\$3A (\$5A)	GIFR	General Interrupt Flag Register			
\$39 (\$59)	TIMSK	Timer/Counter Interrupt Mask register			
\$38 (\$58)	TIFR	Timer/Counter Interrupt Flag register			
\$35 (\$55)	MCUCR	MCU general Control Register			
\$33 (\$53)	TCCR0	Timer/Counter0 Control Register			
\$32 (\$52)	TCNT0	Timer/Counter0 (8-bit)			
\$2F (\$4F)	TCCR1A	Timer/Counter1 Control Register A			
\$2E (\$4E)	TCCR1B	Timer/Counter1 Control Register B			
\$2D (\$4D)	TCNT1H	Timer/Counter1 High Byte			
\$2C (\$4C)	TCNT1L	Timer/Counter1 Low Byte			
\$2B (\$4B)	OCR1AH	Timer/Counter1 Output Compare Register A High Byte			
\$2A (\$4A)	OCR1AL	Timer/Counter1 Output Compare Register A Low Byte			
\$29 (\$49)	OCR1BH	Timer/Counter1 Output Compare Register B High Byte			
\$28 (\$48)	OCR1BL	Timer/Counter1 Output Compare Register B Low Byte			
\$25 (\$45)	ICR1H	T/C 1 Input Capture Register High Byte			
\$24 (\$44)	ICR1L	T/C 1 Input Capture Register Low Byte			
\$21 (\$41)	WDTCR	Watchdog Timer Control Register			
\$1F (\$3E)	EEARH	EEPROM Address Register High Byte (AT90S8515)			
\$1E (\$3E)	EEARL	EEPROM Address Register Low Byte			
\$1D (\$3D)	EEDR	EEPROM Data Register			
\$1C (\$3C)	EECR	EEPROM Control Register			
\$1B (\$3B)	PORTA	Data Register, Port A			
\$1A (\$3A)	DDRA	Data Direction Register, Port A			
\$19 (\$39)	PINA	Input Pins, Port A			
\$18 (\$38)	PORTB	Data Register, Port B			
\$17 (\$37)	DDRB	Data Direction Register, Port B			
\$16 (\$36)	PINB	Input Pins, Port B			
\$15 (\$35)	PORTC	Data Register, Port C			
\$14 (\$34)	DDRC	Data Direction Register, Port C			
\$13 (\$33)	PINC	Input Pins, Port C			
\$12 (\$32)	PORTD	Data Register, Port D			



AT90S8515

External Reset

An external reset is generated by a low level on the RESET pin. Reset pulses longer than 50 ns will generate a reset, even if the clock is not running. Shorter pulses are not guaranteed to generate a reset. When the applied signal reaches the Reset Threshold Voltage (V_{RST}) on its positive edge, the delay timer starts the MCU after the Time-out period t_{TOUT} has expired.





Watchdog Reset

When the Watchdog times out, it will generate a short reset pulse of 1 XTAL cycle duration. On the falling edge of this pulse, the delay timer starts counting the Time-out period t_{TOUT} . Refer to page 42 for details on operation of the Watchdog.





Interrupt Handling

The AT90S8515 has two 8-bit interrupt mask control registers; GIMSK (General Interrupt Mask register) and TIMSK (Timer/Counter Interrupt Mask register).

When an interrupt occurs, the Global Interrupt Enable I-bit is cleared (zero) and all interrupts are disabled. The user software can set (one) the I-bit to enable nested interrupts. The I-bit is set (one) when a Return from Interrupt instruction (RETI) is executed.

For interrupts triggered by events that can remain static (e.g., the Output Compare Register1 matching the value of Timer/Counter1), the interrupt flag is set when the event occurs. If the interrupt flag is cleared and the interrupt condition persists, the flag will not be set until the event occurs the next time.

When the Program Counter is vectored to the actual interrupt vector in order to execute the interrupt handling routine, hardware clears the corresponding flag that generated the





interrupt. Some of the interrupt flags can also be cleared by writing a logical "1" to the flag bit position(s) to be cleared.

If an interrupt condition occurs when the corresponding interrupt enable bit is cleared (zero), the interrupt flag will be set and remembered until the interrupt is enabled or the flag is cleared by software.

If one or more interrupt conditions occur when the global interrupt enable bit is cleared (zero), the corresponding interrupt flag(s) will be set and remembered until the global interrupt enable bit is set (one) and will be executed by order of priority.

Note that external level interrupt does not have a flag and will only be remembered for as long as the interrupt condition is active.

General Interrupt Mask Register – GIMSK



Bit 7 – INT1: External Interrupt Request 1 Enable

When the INT1 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control1 bits 1/0 (ISC11 and ISC10) in the MCU general Control Register (MCUCR) define whether the external interrupt is activated on rising or falling edge of the INT1 pin or is level-sensed. Activity on the pin will cause an interrupt request even if INT1 is configured as an output. The corresponding interrupt of External Interrupt Request 1 is executed from program memory address \$002. See also "External Interrupts".

• Bit 6 – INT0: External Interrupt Request 0 Enable

When the INT0 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control0 bits 1/0 (ISC01 and ISC00) in the MCU general Control Register (MCUCR) define whether the external interrupt is activated on rising or falling edge of the INT0 pin or is level-sensed. Activity on the pin will cause an interrupt request even if INT0 is configured as an output. The corresponding interrupt of External Interrupt Request 0 is executed from program memory address \$001. See also "External Interrupts".

• Bits 5..0 - Res: Reserved Bits

These bits are reserved bits in the AT90S8515 and always read as zero.

General Interrupt Flag Register – GIFR



• Bit 7 – INTF1: External Interrupt Flag1

When an edge on the INT1 pin triggers an interrupt request, the corresponding interrupt flag, INTF1 becomes set (one). If the I-bit in SREG and the corresponding interrupt enable bit, INT1 in GIMSK is set (one), the MCU will jump to the interrupt vector. The flag is cleared when the interrupt routine is executed. Alternatively, the flag can be cleared by writing a logical "1" to it. This flag is always cleared when INT1 is configured as level interrupt.







The system is single-buffered in the transmit direction and double-buffered in the receive direction. This means that bytes to be transmitted cannot be written to the SPI Data Register before the entire shift cycle is completed. When receiving data, however, a received byte must be read from the SPI Data Register before the next byte has been completely shifted in. Otherwise, the first byte is lost.

When the SPI is enabled, the data direction of the MOSI, MISO, SCK and \overline{SS} pins is overridden according to Table 15.

Table 1	5. S	PI Pin	Overrides
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Pin	Direction, Master SPI	Direction, Slave SPI
MOSI	User Defined	Input
MISO	Input	User Defined
SCK	User Defined	Input
SS	User Defined	Input

Note: See "Alternate Functions of Port B" on page 66 for a detailed description of how to define the direction of the user-defined SPI pins.

SS Pin Functionality When the SPI is configured as a master (MSTR in SPCR is set), the user can determine the direction of the SS pin. If SS is configured as an output, the pin is a general output pin, which does not affect the SPI system. If SS is configured as an input, it must be held high to ensure master SPI operation. If the SS pin is driven low by peripheral circuitry when the SPI is configured as master with the SS pin defined as an input, the SPI system interprets this as another master selecting the SPI as a slave and starts to send data to it. To avoid bus contention, the SPI system takes the following actions:

- 1. The MSTR bit in SPCR is cleared and the SPI system becomes a slave. As a result of the SPI becoming a slave, the MOSI and SCK pins become inputs.
- 2. The SPIF flag in SPSR is set, and if the SPI interrupt is enabled and the I-bit in SREG is set, the interrupt routine will be executed.

Thus, when interrupt-driven SPI transmittal is used in Master Mode and there exists a possibility that \overline{SS} is driven low, the interrupt should always check that the MSTR bit is still set. Once the MSTR bit has been cleared by a slave select, it must be set by the user to re-enable SPI Master Mode.

When the SPI is configured as a slave, the \overline{SS} pin is always input. When \overline{SS} is held low, the SPI is activated and MISO becomes an output if configured so by the user. All other



• Bit 5 – DORD: Data Order

When the DORD bit is set (one), the LSB of the data word is transmitted first.

When the DORD bit is cleared (zero), the MSB of the data word is transmitted first.

• Bit 4 – MSTR: Master/Slave Select

This bit selects Master SPI Mode when set (one), and Slave SPI Mode when cleared (zero). If \overline{SS} is configured as an input and is driven low while MSTR is set, MSTR will be cleared and SPIF in SPSR will become set. The user will then have to set MSTR to reenable SPI Master Mode.

Bit 3 – CPOL: Clock Polarity

When this bit is set (one), SCK is high when idle. When CPOL is cleared (zero), SCK is low when idle. Refer to Figure 36 and Figure 37 for additional information.

• Bit 2 – CPHA: Clock Phase

Refer to Figure 36 or Figure 37 for the functionality of this bit.

• Bits 1, 0 – SPR1, SPR0: SPI Clock Rate Select 1 and 0

These two bits control the SCK rate of the device configured as a master. SPR1 and SPR0 have no effect on the slave. The relationship between SCK and the oscillator clock frequency f_{cl} is shown in Table 16.

Table 16.	Relationship	between	SCK and	the C	Dscillator	Frequency
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SPR1	SPR0	SCK Frequency
0	0	f _{cl} /4
0	1	f _c /16
1	0	f _{cl} /64
1	1	f _c /128

SPI Status Register – SPSR

Bit	7	6	5	4	3	2	1	0	_
\$0E (\$2E)	SPIF	WCOL	-	-	-	-	-	-	SPSR
Read/Write	R	R	R	R	R	R	R	R	-
nitial Value	0	0	0	0	0	0	0	0	

Bit 7 – SPIF: SPI Interrupt Flag

When a serial transfer is complete, the SPIF bit is set (one) and an interrupt is generated if SPIE in SPCR is set (one) and global interrupts are enabled. If SS is an input and is driven low when the SPI is in Master Mode, this will also set the SPIF flag. SPIF is cleared by hardware when executing the corresponding interrupt handling vector. Alternatively, the SPIF bit is cleared by first reading the SPI Status Register when SPIF is set (one), then by accessing the SPI Data Register (SPDR).

Bit 6 – WCOL: Write Collision Flag

The WCOL bit is set if the SPI Data Register (SPDR) is written during a data transfer. The WCOL bit (and the SPIF bit) are cleared (zero) by first reading the SPI Status Register when WCOL is set (one), and then by accessing the SPI Data Register.

Bits 5..0 – Res: Reserved Bits

These bits are reserved bits in the AT90S8515 and will always read as zero.

The SPI interface on the AT90S8515 is also used for program memory and EEPROM downloading or uploading. See page 86 for serial programming and verification.

If the 10(11)-bit Transmitter shift register is empty, data is transferred from UDR to the shift register. At this time the UDRE (UART Data Register Empty) bit in the UART Status Register, USR, is set. When this bit is set (one), the UART is ready to receive the next character. At the same time as the data is transferred from UDR to the 10(11)-bit shift register, bit 0 of the shift register is cleared (start bit) and bit 9 or 10 is set (stop bit). If 9-bit data word is selected (the CHR9 bit in the UART Control Register, UCR is set), the TXB8 bit in UCR is transferred to bit 9 in the Transmit shift register.

On the baud rate clock following the transfer operation to the shift register, the start bit is shifted out on the TXD pin. Then follows the data, LSB first. When the stop bit has been shifted out, the shift register is loaded if any new data has been written to the UDR during the transmission. During loading, UDRE is set. If there is no new data in the UDR register to send when the stop bit is shifted out, the UDRE flag will remain set until UDR is written again. When no new data has been written and the stop bit has been present on TXD for one bit length, the TX Complete flag (TXC) in USR is set.

The TXEN bit in UCR enables the UART Transmitter when set (one). When this bit is cleared (zero), the PD1 pin can be used for general I/O. When TXEN is set, the UART Transmitter will be connected to PD1, which is forced to be an output pin regardless of the setting of the DDD1 bit in DDRD.

Data Reception Figure 39 shows a block diagram of the UART Receiver.







PORTAn has to be cleared (zero) or the pin has to be configured as an output pin. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not active..

Table 19. DDAn Effects on Port A Pins

DDAn	PORTAn	I/O	Pull-up	Comment
0	0	Input	No	Tri-state (high-Z)
0	1	Input	Yes	PAn will source current if ext. pulled low.
1	0	Output	No	Push-pull Zero Output
1	1	Output	No	Push-pull One Output

Note: n: 7,6...0, pin number.

Port A Schematics Note that all port pins are synchronized. The synchronization latch is, however, not shown in the figure.







Port B as General Digital I/O All eight pins in Port B have equal functionality when used as digital I/O pins.

PBn, general I/O pin: The DDBn bit in the DDRB register selects the direction of this pin. If DDBn is set (one), PBn is configured as an output pin. If DDBn is cleared (zero), PBn is configured as an input pin. If PORTBn is set (one) when the pin is configured as an input pin, the MOS pull-up resistor is activated. To switch the pull-up resistor off, the PORTBn has to be cleared (zero) or the pin has to be configured as an output pin. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not active.

DDBn	PORTBn	I/O	Pull up	Comment
0	0	Input	No	Tri-state (high-Z)
0	1	Input	Yes	PBn will source current if ext. pulled low.
1	0	Output	No	Push-pull Zero Output
1	1	Output	No	Push-pull One Output

Table 21. DDBn Effects on Port B Pins

Note: n: 7,6...0, pin number.

Alternate Functions of Port B

The alternate pin configuration is as follows:

• SCK – Port B, Bit 7

SCK: Master clock output, slave clock input pin for SPI channel. When the SPI is enabled as a slave, this pin is configured as an input regardless of the setting of DDB7. When the SPI is enabled as a master, the data direction of this pin is controlled by DDB7. When the pin is forced to be an input, the pull-up can still be controlled by the PORTB7 bit. See the description of the SPI port for further details.

• MISO – Port B, Bit 6

MISO: Master data input, slave data output pin for SPI channel. When the SPI is enabled as a master, this pin is configured as an input regardless of the setting of DDB6. When the SPI is enabled as a slave, the data direction of this pin is controlled by DDB6. When the pin is forced to be an input, the pull-up can still be controlled by the PORTB6 bit. See the description of the SPI port for further details.

• MOSI – Port B, Bit 5

MOSI: SPI Master data output, slave data input for SPI channel. When the SPI is enabled as a slave, this pin is configured as an input regardless of the setting of DDB5. When the SPI is enabled as a master, the data direction of this pin is controlled by DDB5. When the pin is forced to be an input, the pull-up can still be controlled by the PORTB5 bit. See the description of the SPI port for further details.

• SS – Port B, Bit 4

 \overline{SS} : Slave port select input. When the SPI is enabled as a slave, this pin is configured as an input regardless of the setting of DDB4. As a slave, the SPI is activated when this pin is driven low. When the SPI is enabled as a master, the data direction of this pin is controlled by DDB4. When the pin is forced to be an input, the pull-up can still be controlled by the PORTB4 bit. See the description of the SPI port for further details.

• AIN1 - Port B, Bit 3

AIN1: Analog Comparator Negative Input. When configured as an input (DDB3 is cleared [zero]) and with the internal MOS pull-up resistor switched off (PB3 is cleared [zero]), this pin also serves as the negative input of the On-chip Analog Comparator.



Figure 47. Port B Schematic Diagram (Pins PB2 and PB3)



Figure 48. Port B Schematic Diagram (Pin PB4)





Port C Schematics

Note that all port pins are synchronized. The synchronization latch is, however, not shown in the figure.





Port D

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors.

Three I/O memory address locations are allocated for the Port D, one each for the Data Register – PORTD, \$12(\$32), Data Direction Register – DDRD, \$11(\$31) and the Port D Input Pins – PIND, \$10(\$30). The Port D Input Pins address is read-only, while the Data Register and the Data Direction Register are read/write.

The Port D output buffers can sink 20 mA. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated.

Some Port D pins have alternate functions as shown in Table 23.

Port Pin	Alternate Function
PD0	RXD (UART Input Line)
PD1	TXD (UART Output Line)
PD2	INT0 (External interrupt 0 Input)
PD3	INT1 (External interrupt 1 Input)
PD5	OC1A (Timer/Counter1 Output CompareA Match Output)
PD6	WR (Write Strobe to External Memory)
PD7	RD (Read Strobe to External Memory)

Table 23. Port D Pin Alternate Functions

When the pins are used for the alternate function, the DDRD and PORTD registers have to be set according to the alternate function description.



Memory Programming

Program and Data Memory Lock Bits

The AT90S8515 MCU provides two Lock bits that can be left unprogrammed ("1") or can be programmed ("0") to obtain the additional features listed in Table 25. The Lock bits can only be erased with the Chip Erase command.

Table 25. Lock Bit Protection Modes

	Memo	Memory Lock Bits		
	Mode	LB1	LB2	Protection Type
	1	1	1	No memory lock features enabled.
	2	0	1	Further programming of the Flash and EEPROM is disabled. ⁽¹⁾
	3	0	0	Same as mode 2, and verify is also disabled.
	Note:	I. In Pa Fuse	arallel Mo bits bef	ode, further programming of the Fuse bits is also disabled. Program the ore programming the Lock bits.
Fuse Bits	The AT9	0S851	5 has tw	o Fuse bits, SPIEN and FSTRT.
	 Whe is en 	n the S abled.	PIEN F Default	use is programmed ("0"), Serial Program and Data Downloading value is programmed ("0").
	 Whe Defa be d 	n the F ult valu elivered	STRT F e is unp d on der	Fuse is programmed ("0"), the short start-up time is selected. programmed ("1"). Parts with this bit pre-programmed ("0") can mand.
	The Fus bits is no	e bits a t affect	re not a ed by C	accessible in Serial Programming Mode. The status of the Fuse hip Erase.
Signature Bytes	All Atme This cod arate ade	l micro e can b dress s	controll e read i pace.	ers have a three-byte signature code that identifies the device. In both Serial and Parallel mode. The three bytes reside in a sep-
	For the A	T90S8	515 ⁽¹⁾ t	hey are:
	1. \$000): \$1E (indicate	es manufactured by Atmel)
	2. \$001	: \$93 (indicate	s 8 KB Flash memory)
	3. \$002	2: \$01 (indicate	s AT90S8515 device when signature byte \$001 is \$93)
	Note:	read	n both L in Serial	ock bits are programmed (lock mode 3), the signature bytes cannot be Mode. Reading the signature bytes will return: \$00, \$01 and \$02.
Programming the Flash and EEPROM	Atmel's memory	AT90S and 51	8515 o 2 bytes	ffers 8K bytes of In-System Reprogrammable Flash program of EEPROM data memory.
	The AT9 arrays ir device s Serial Pr rent of s convenie system.	0S8515 the er upports ogramr ignifica ent way	5 is ship rased s s a high ning Mo ance is v to dow	ped with the On-chip Flash program and EEPROM data memory tate (i.e., contents = \$FF) and ready to be programmed. This n-voltage (12V) Parallel Programming Mode and a low-voltage ode. The +12V is used for programming enable only, and no cur- drawn by this pin. The Serial Programming Mode provides a nload program and data into the AT90S8515 inside the user's
	The proc	iram an	d data i	memory arrays on the AT90S8515 are programmed byte-by-byte

The program and data memory arrays on the AT90S8515 are programmed byte-by-byte in either programming mode. For the EEPROM, an auto-erase cycle is provided within



Table 27. Pin Name Mapping

Signal Name in Programming Mode	Pin Name	I/O	Function
RDY/BSY	PD1	0	0: Device is busy programming, 1: Device is ready for new command
ŌĒ	PD2	I	Output Enable (Active low)
WR	PD3	Ι	Write Pulse (Active low)
BS	PD4	I	Byte Select ("0" selects low byte, "1" selects high byte)
XA0	PD5	Ι	XTAL Action Bit 0
XA1	PD6	Ι	XTAL Action Bit 1
DATA	PB7-0	I/O	Bi-directional Data Bus (Output when \overline{OE} is low)

Table 28. XA1 and XA0 Coding

XA1	XA0	Action when XTAL1 is Pulsed
0	0	Load Flash or EEPROM Address (High or low address byte determined by BS)
0	1	Load Data (High or low data byte for Flash determined by BS)
1	0	Load Command
1	1	No Action, Idle

 Table 29.
 Command Byte Bit Coding

Command Byte	Command Executed
1000 0000	Chip Erase
0100 0000	Write Fuse Bits
0010 0000	Write Lock Bits
0001 0000	Write Flash
0001 0001	Write EEPROM
0000 1000	Read Signature Bytes
0000 0100	Read Lock and Fuse Bits
0000 0010	Read Flash
0000 0011	Read EEPROM

Enter Programming Mode

The following algorithm puts the device in Parallel Programming Mode:

- 1. Apply supply voltage according to Table 26, between V_{CC} and GND.
- 2. Set the $\overline{\text{RESET}}$ and BS pin to "0" and wait at least 100 ns.
- 3. Apply 11.5 12.5V to RESET. Any activity on BS within 100 ns after +12V has been applied to RESET will cause the device to fail entering programming mode.



			4 MHz Oscillator		Variable Oscillator		
	Symbol	Parameter	Min	Max	Min	Мах	Unit
0	1/t _{CLCL}	Oscillator Frequency			0.0	4.0	MHz
1	t _{LHLL}	ALE Pulse Width	70.0		0.5 t _{CLCL} - 55.0 ⁽¹⁾		ns
2	t _{AVLL}	Address Valid A to ALE Low	60.0		0.5 t _{CLCL} - 65.0 ⁽¹⁾		ns
За	t _{LLAX_ST}	Address Hold after ALE Low, ST/STD/STS Instructions	130.0		$0.5 t_{CLCL} + 5.0^{(2)}$		ns
Зb	t _{LLAX_LD}	Address Hold after ALE Low, LD/LDD/LDS Instructions	15.0		15.0		ns
4	t _{AVLLC}	Address Valid C to ALE Low	60.0		0.5 t _{CLCL} - 65.0 ⁽¹⁾		ns
5	t _{AVRL}	Address Valid to RD Low	200.0		1.0 t _{CLCL} - 50.0		ns
6	t _{AVWL}	Address Valid to WR Low	325.0		1.5 t _{CLCL} - 50.0 ⁽¹⁾		ns
7	t _{LLWL}	ALE Low to WR Low	230.0	270.0	1.0 t _{CLCL} - 20.0	1.0 t _{CLCL} + 20.0	ns
8	t _{LLRL}	ALE Low to RD Low	105.0	145.0	0.5 t _{CLCL} - 20.0 ⁽²⁾	$0.5 t_{CLCL} + 20.0^{(2)}$	ns
9	t _{DVRH}	Data Setup to RD High	95.0		95.0		ns
10	t _{RLDV}	Read Low to Data Valid		170.0		1.0 t _{CLCL} - 80.0	ns
11	t _{RHDX}	Data Hold after RD High	0.0		0.0		ns
12	t _{RLRH}	RD Pulse Width	230.0		1.0 t _{CLCL} - 20.0		ns
13	t _{DVWL}	Data Setup to WR Low	70.0		0.5 t _{CLCL} - 55.0 ⁽¹⁾		ns
14	t _{WHDX}	Data Hold after WR High	0.0		0.0		ns
15	t _{DVWH}	Data Valid to WR High	210.0		1.0 t _{CLCL} - 40.0		ns
16	t _{wLWH}	WR Pulse Width	105.0		0.5 t _{CLCL} - 20.0 ⁽²⁾		ns

Table 39. External Data Memory Characteristics, 2.7V - 4.0V, No Wait State

Table 40. External Data Memory Characteristics, 2.7V - 4.0V, One Cycle Wait State

			4 MHz Oscillator		Variable Oscillator			
	Symbol	Parameter	Min	Max	Min	Мах	Unit	
0	1/t _{CLCL}	Oscillator Frequency			0.0	4.0	MHz	
10	t _{RLDV}	Read Low to Data Valid		420.00		2.0 t _{CLCL} - 80.0	ns	
12	t _{RLRH}	RD Pulse Width	480.0		2.0 t _{CLCL} - 20.0		ns	
15	t _{DVWH}	Data Valid to WR High	460.0		2.0 t _{CLCL} - 40.0		ns	
16	t _{wLWH}	WR Pulse Width	355.0		1.5 t _{CLCL} - 20.0 ⁽²⁾		ns	
Notes: 1. This assumes 50% clock duty cycle. The half-period is actually the high time of the external clock, XIAL1.								

1. This assumes 50% clock duty cycle. The half-period is actually the high time of the external clock, XTAL1.

2. This assumes 50% clock duty cycle. The half-period is actually the low time of the external clock, XTAL1.



Figure 70. Active Supply Current vs. V_{CC}



Figure 71. Idle Supply Current vs. Frequency













WATCHDOG OSCILLATOR FREQUENCY vs. V_{cc}



Figure 84. I/O Pin Source Current vs. Output Voltage





